Tyrone Camarero Specifications

Camarero SSA200A2T-26

Key features

HPC, Cloud Gaming, MEC (Multi-Access Edge Computing), Multi-Purpose CDN, High-availability Cache Cluster, Telco Edge Cloud, EDA (Electric Design Automation), Mission Critical Web Applications

Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Single-Socket, AMD EPYC[™] 9004 Series Processors up to 290W TDP
- 12 DIMM Slots, up to 3TB DDR5 memory
- 2 AIOM / OCP 3.0 slots
- Up to 6 Hot-swap 2.5"NVMe/SATA drives, M.2 : 2 M.2 NVMe OR 2 M.2 SATA3
- Redundant 2200w Titanium Level(96%)High-Efficiency Power Supplies with I2C & PMBus
- 2x 17.6K RPM Heavy Duty 8cm Fan(s), 1 per node Air Shroud(s)





Processor/Cache

Single-Socket, AMD EPYC™ 9004 Series Processors Processor

up to 290W TDP

Note: Certain CPUs with high TDP may be supported only under specific conditions. Please contact Supermicro Technical Support for additional information about specialized system optimization.

Chipset

Chipset AMD SP5

System Memory

12 DIMM slots , Up to 3TB: 12x 256 **Memory Capacity**

GB DRAM,

Memory Type: 4800MHz ECC DDR5

RDIMM

Expansion Slots

PCI-Express 2 AIOM / OCP 3.0 slots

Integrated On board

IPMI Support for Intelligent Platform

> Management Interface v.2.0, IPMI 2.0 with virtual media over LAN and KVM-over-LAN support 1 RJ45 Dedicated BMC LAN port

Add-on Options

LAN

Raid Card None Optical Drive None

Front Panel

HDD activity LED, Network activity LEDs, LED:

Power status LED, Universal Information

(UID) LED

Buttons: Power On/Off, UID button

Drive Bays

Up to 6 Hot-swap 2.5"NVMe/ SATA drives(6x 2.5" NVMe hybrid), M.2: 2 M.2 NVMe OR 2 M.2 SATA3

Power Supply

Redundant 2200w Titanium Level(96%) High-Efficiency Power Supplies with I2C & amp; PMBus

Form Factor

Form Factor 2U Rackmount

Dimensions: Height - 3.46" (88mm),

> Width - 17.67" (449mm), Depth - 28" (711.2mm)

Email: info@tyronesystems.com For more/current product information, visit www.tyronesystems.com

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